#### **SPECIFICATIONS:**

Insulation Resistance:  $1,000M\Omega$  min. at 100V DC Withstanding Voltage: 300Vrms for 1min

Withstanding Voltage: 300Vrms Voltage Rating: 30V AC

Current Rating: Contacts - 0.5A, Power Pins – 1.0A Contact Resistance:  $10m\Omega$  max. at 20mV max.

Operating Temp.: +65°C MAX Mating Cycle: 100 times

#### **MATERIALS AND FINISH:**

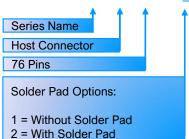
Blade Contacts: Cu AlloySolder Pad: Cu Alloy

· Insulator & Over mold: LCP

# QSFP-DD MSA COMPLIANT

#### **PART NUMBER:**

CN174S-076-000X

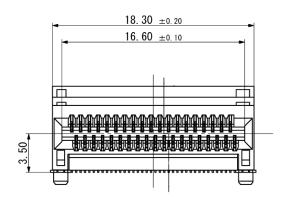


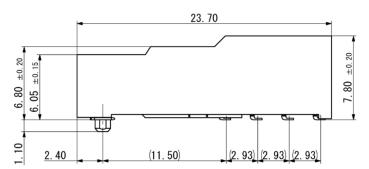
#### **FEATURES**:

- · QSFP-DD MSA Design Guideline Compliant
- · Supports signals:
  - 28Gbps-NRZ & 56Gbps-PAM4 for 200G & 400G
  - o Next Gen. 112Gbps-PAM4 for 800G

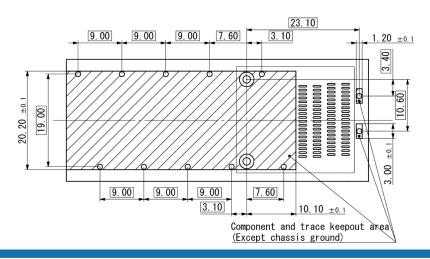


#### **OUTLINE DIMENSIONS:**





#### **RECOMMENDED PC BOARD LAYOUT:**



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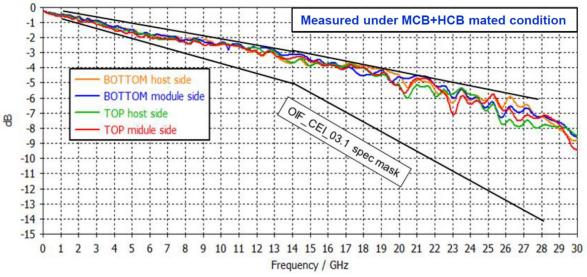
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## YAMAICHI ELECTRONICS

# **QSFP-DD Solution**

### **Insertion Loss Measurements for 1x1 QSFP-DD**

S-Parameters [Magnitude in dB]



### **Return Loss Measurements for 1x1 QSFP-DD**

S-Parameters [Magnitude in dB]

